

DIM	INCHES		MILLIMETERS	
	Min	MAX	MIN	MAX
A	.0532	.0688	1,35	1.75
A1	.0040	.0098	0.10	0.25
В	.014	.018	0.36	0.46
С	.0075	.0098	0.19	0.25
D	.189	.196	4.80	4.98
Е	.150	.157	3.81	3.99
е	.050 BASIC		1.27 BASIC	
e 1	.025 BASIC		0.635 BASIC	
н	.2284	.2440	5.80	6.20
к	.011	.019	0.28	0.48
L	.016	.050	0.41	1.27
у	0.	8*	0.	8'

NOTES:

- DIMENSIONING & TOLERANCING PER ANSI Y14.5M-1982.
- 2. CONTROLLING DIMENSION: MILLIMETER.
- 3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].

- 4. OUTLINE CONFORMS TO JEDEC OUTLINE MS-012AA.
 DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.25 [.006].
- DIMENSION IS THE LENGTH OF LEAD FOR SOLDERING TO A SUBSTRATE.

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